

THYRISTORS 2S2M, 2S4M

2 A HIGH-SPEED SWITCHING SCR

The 2S2M and 2S4M are P-gate fully diffused mold SCRs with an average on-current of 2 A. The repeat peak off-voltages (and reverse voltages) are 200 V and 400 V.

FEATURES

- This transistor is designed for high-speed switching and is deal for use in commercial frequencies, high-frequency pulse applications, and inverter applications.
- This transistor features a small and lightweight package and is easy to handle even on the mounting surface due to its TO-202AA dimensions. Processing of lead wires and heatsink (tablet) using jigs is also possible.
- Employs flame-retardant epoxy resin (UL94V-0).

APPLICATIONS

Consumer electronic euipments, ignitors of devices for light indutry, inverter, and solenoid valve drives

PACKAGE DRAWING (UNIT: mm) 3.2 1.3 2.552.55 Electrode connection <1>Cathode <2>Anode <3>Gate Standard weight: 1.4

*TC test bench-mark

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	2S2M	2S4M	Ratings	Unit
Non-repetitive peak reverse voltage	VRSM	300	500	V	$R_{GK} = 1 k\Omega$
Non-repetitive peak off-state voltage	VDSM	300	500	V	$R_{GK} = 1 k\Omega$
Repetitive peak reverse voltage	V _{RRM}	200	400		$R_{GK} = 1 k\Omega$
Repetitive peak off-voltage	V _{DRM}	200	400	V	$R_{GK} = 1 k\Omega$
Average on-state current	I _{T(AV)}	2 (Tc = 77°C, Single	Α	Refer to Figure 6 snd 7.	
Surge on-state current	Ітѕм	20 (f = 50 Hz, Sine	Α	Refer to Figure 2.	
High-frequency peak on-state current	ITRM	15 (Tc = 65°C, f = 1	Α	-	
Fusing current	∫it²dt	1.6 (1 ms	A ² s	-	
Critical rate of rise of on-state current	dl⊤/dt	5	A/μs	-	
Peak gate power dissipation	Рам	0.5 (f≥50 Hz, Duty≤10%)		W	-
Average gate power dissipation	P _{G(AV)}	0.1		W	
Peak gate forward current	lгдм	0.2 (f≥50 Hz	Α	-	
Peak gate reverse voltage	Vrgm	(V	-	
Junction temperature	Tj	-40 to	°C	-	
Storage temperature	Tstg	−55 tp	°C	-	

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

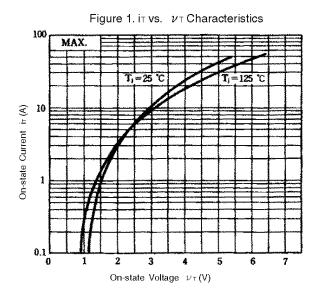
Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

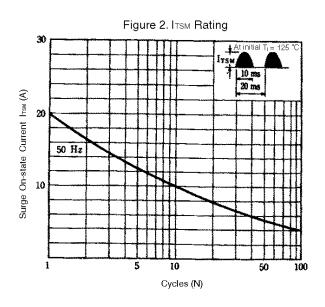


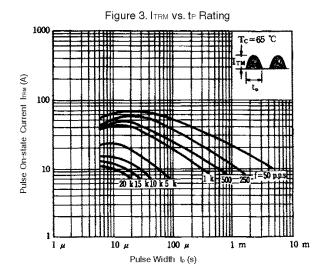
ELECTRICAL CHARACTERISTICS (Tj = 25°C, Rg κ = 1 k Ω)

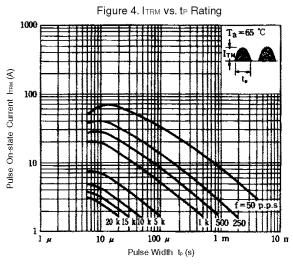
Parameter	Symbol	Conditions		Specifications			Unit	Remarks
				MIN.	TYP.	MAX.	ļ	
Repeat peak off-state current	IDRM	V _{DM} = V _{DRM}	T _j = 25°C			10	μΑ	-
			T _j = 125°C			200		_
Repetitive peak reverse current	IRRM	V _{RM} = V _{RRM}	T _j = 25°C			10	μΑ	_
			T _j = 125°C			200	V	Refer to Figure 1.
On voltage	Vтм	T _j = 25°С, Iтм = 4 A		_	-	2.2	V	Refer to Figure 9.
Gate trigger voltage	V GT	$V_{DM} = 6 \text{ V}, \text{ RL} = 100 \Omega$		_	-	0.8	μΑ	Refer to Figure 8.
Gate trigger current	Іст	$V_{DM} = 6 \text{ V}, \text{ RL} = 100 \Omega$		_	-	300	V	_
Gate non-trigger voltage	V _{GD}	$T_j = 125^{\circ}C, V_{DM} = \frac{1}{2}V_{DRM}$		0.2	-	_	V	_
Critical rate of-rise of off- state voltage	d√/dt	$T_j = 125^{\circ}C, V_{DM} = \frac{2}{3}V_{DRM}$		10	_	-	V/μs	-
Holding current	Ін	$T_j = 25^{\circ}C, V_D = 24 V$		_	-	10	mA	-
Commutating turn-off time	Tq	$T_{\rm j} = 125^{\circ}\text{C}, \ \text{IT} = 2 \text{ A}$ $V_{\rm DM} = \frac{2}{3}V_{\rm DRM}, \ V_{\rm R} = 50 \text{ V}$ $dv/dt = 10 \text{ V}/\mu\text{s}$		_		15	μs	
Turn-on time	Tgt	$T_{i} = 125^{\circ}\text{C}$, $V_{DM} = \frac{2}{3}V_{DRM}$ $I_{TM} = 30 \text{ A}$ $I_{G} = 5 \text{ mA}$, $t_{1G} = 5 \mu \text{s}$		_	_	2	μs	-
Thermal resistance	Rth(j-c)	Junction-to-case DC Junction-to-ambient DC		_	_	10	°C/W	Refer to Figure 13.
	R _{th(j-a)}			-	-	75		

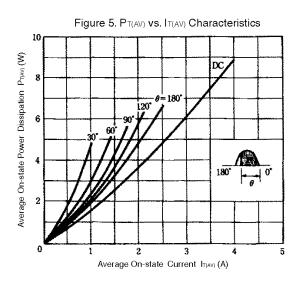
TYPICAL CHARACTERISTICS (Ta = 25°C)

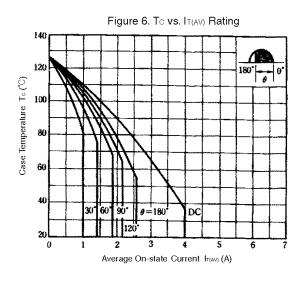


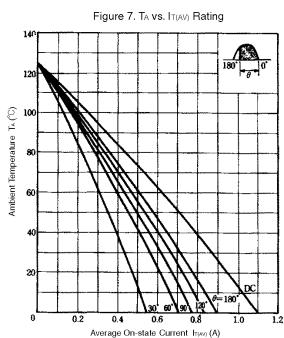


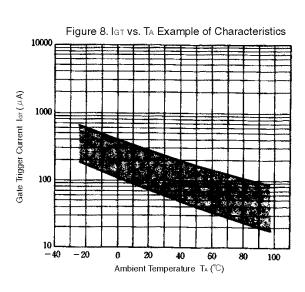


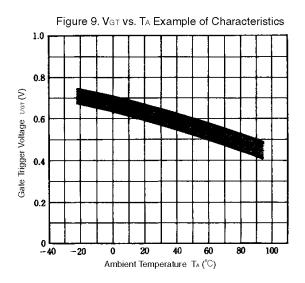


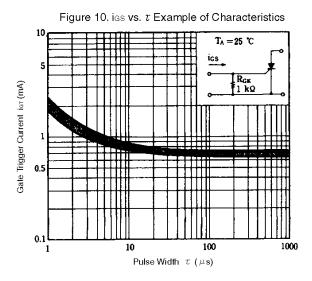


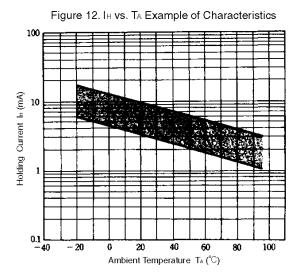


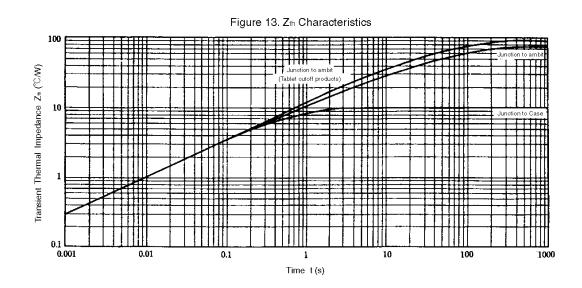














[MEMO]

- The information in this document is current as of July, 2001. The information is subject to change
 without notice. For actual design-in, refer to the latest publications of NEC's data sheets or data
 books, etc., for the most up-to-date specifications of NEC semiconductor products. Not all products
 and/or types are available in every country. Please check with an NEC sales representative for
 availability and additional information.
- No part of this document may be copied or reproduced in any form or by any means without prior written consent of NEC. NEC assumes no responsibility for any errors that may appear in this document.
- NEC does not assume any liability for infringement of patents, copyrights or other intellectual property rights of
 third parties by or arising from the use of NEC semiconductor products listed in this document or any other
 liability arising from the use of such products. No license, express, implied or otherwise, is granted under any
 patents, copyrights or other intellectual property rights of NEC or others.
- Descriptions of circuits, software and other related information in this document are provided for illustrative
 purposes in semiconductor product operation and application examples. The incorporation of these
 circuits, software and information in the design of customer's equipment shall be done under the full
 responsibility of customer. NEC assumes no responsibility for any losses incurred by customers or third
 parties arising from the use of these circuits, software and information.
- While NEC endeavours to enhance the quality, reliability and safety of NEC semiconductor products, customers
 agree and acknowledge that the possibility of defects thereof cannot be eliminated entirely. To minimize
 risks of damage to property or injury (including death) to persons arising from defects in NEC
 semiconductor products, customers must incorporate sufficient safety measures in their design, such as
 redundancy, fire-containment, and anti-failure features.
- NEC semiconductor products are classified into the following three quality grades:
 - "Standard", "Special" and "Specific". The "Specific" quality grade applies only to semiconductor products developed based on a customer-designated "quality assurance program" for a specific application. The recommended applications of a semiconductor product depend on its quality grade, as indicated below. Customers must check the quality grade of each semiconductor product before using it in a particular application.
 - "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
 - "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC semiconductor products is "Standard" unless otherwise expressly specified in NEC's data sheets or data books, etc. If customers wish to use NEC semiconductor products in applications not intended by NEC, they must contact an NEC sales representative in advance to determine NEC's willingness to support a given application.

(Note)

- (1) "NEC" as used in this statement means NEC Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC semiconductor products" means any semiconductor product developed or manufactured by or for NEC (as defined above).

M8E 00.4